## Board to Board Connectors

## Features:

- Robust, shrouded design with screw-machined terminals and multi-finger contacts can withstand the rigorous demands of blind mating and mating/unmating cycles.
- At 3 amps per pin, more contacts can be assigned to data/signal transfer (fewer pins needed to handle power and ground).
- High density - over 400 contacts per square inch.
- Industry standard footprints in four mated heights.
- Precision molded with integral polarization keying features.


## Specifications:

## Terminals:

Brass - Copper Alloy (C36000) ASTM-B-16
Contacts:
Beryllium Copper
(C17200) ASTM-B-194

## Solder Ball:

Standard: 63Sn/37Pb
Lead-free: $95.5 \mathrm{Sn} / 4.0 \mathrm{Ag} / 0.5 \mathrm{Cu}$
Plating:
G - Gold over Nickel
Gold per ASTM-B-488
Nickel per QQ-N-290

## Table of Models



Description: Molded B2B® Connector (BB)
Material: High Temp. Liquid Crystal Polymer (LCP) Index: $-40^{\circ} \mathrm{C}$ to $260^{\circ} \mathrm{C}\left(-40^{\circ} \mathrm{F}\right.$ to $\left.500^{\circ} \mathrm{F}\right)$

Description: Molded B2B ${ }^{\circledR}$ Connector (BA)
Material: High Temp. Liquid Crystal Polymer (LCP)
Index: $-40^{\circ} \mathrm{C}$ to $260^{\circ} \mathrm{C}\left(-40^{\circ} \mathrm{F}\right.$ to $\left.500^{\circ} \mathrm{F}\right)$

## Performance

| Mated Height | Differential Insertion Loss | Differential Return Loss |
| :---: | :---: | :---: |
| 6.00 mm | $-.20 \mathrm{~dB} @ 1.70 \mathrm{GHz}$ | $-10 \mathrm{~dB} @ 3.30 \mathrm{GHz}$ |
|  | $-.50 \mathrm{~dB} @ 3.30 \mathrm{GHz}$ | $-15 \mathrm{~dB} @ 1.70 \mathrm{GHz}$ |
| 8.00 mm | $-.15 \mathrm{~dB} @ 1.30 \mathrm{GHz}$ | $-10 \mathrm{~dB} @ 2.50 \mathrm{GHz}$ |
|  | $-.50 \mathrm{~dB} @ 2.50 \mathrm{GHz}$ | $-15 \mathrm{~dB} @ 1.30 \mathrm{GHz}$ |
| 12.70 mm | $-.20 \mathrm{~dB} @ 1.70 \mathrm{GHz}$ | $-10 \mathrm{~dB} @ 3.40 \mathrm{GHz}$ |
|  | $-.51 \mathrm{~dB} @ 3.40 \mathrm{GHz}$ | $-15 \mathrm{~dB} @ 1.70 \mathrm{GHz}$ |
| 19.05 mm | $-.60 \mathrm{~dB} @ 2.20 \mathrm{GHz}$ | $-10 \mathrm{~dB} @ 2.20 \mathrm{GHz}$ |
|  | $-.20 \mathrm{~dB} @ 1.40 \mathrm{GHz}$ | $-15 \mathrm{~dB} @ 1.40 \mathrm{GHz}$ |

Insertion Force ( $6.00 \mathrm{~mm}, 300$ position): 50 g average (per pin)

Extraction Force $(6.00 \mathrm{~mm}, 300$ position): 45 g average (per pin)

Durability (mated cycles): 500 cycles ( $<10 \mathrm{~m} \Omega$ change in resistance)

Additional performance and test data available online.

## How To Order

Female


Male

*500 pos. available in 6 mm mated height only.
**If no packaging code is indicated, male connectors are supplied with pick-up caps in standard trays.

B2B ${ }^{\circledR}$ High Density SMT Connectors . $050 /(1.27 \mathrm{~mm})$ Pitch

## Standard Footprints

|  |
| :---: |
|  |  |
|  |  |
|  |  |

[^0]$\rightarrow \leftarrow .050 /(1.27)$ Typ.

|  | - 300 Positions <br> - $30 \times 10$ Rows |
| :---: | :---: |
| $\rightarrow \mid \leqslant .050 /(1.27)$ Typ. |  |
|  | - 400 Positions <br> - $40 \times 10$ Rows |
| $\rightarrow \mid \leftarrow .050 /(1.27)$ Typ. |  |
|  | - 500 Positions <br> - $50 \times 10$ Rows |
| $\rightarrow \mid<.050 /(1.27)$ Typ. |  |

Consult factory for custom sizes.

## Dimensional Information



| Mated Board to Board Height* | $\begin{gathered} \text { A } \\ \text { in. } /(\mathrm{mm}) \end{gathered}$ | $\begin{gathered} \text { B } \\ \text { in./(mm) } \end{gathered}$ | $\begin{gathered} \mathrm{C}^{\wedge} \\ \text { in./(mm) } \end{gathered}$ | $\begin{gathered} D^{\wedge} \\ \text { in./(mm) } \end{gathered}$ | $\begin{gathered} \mathrm{E}^{\wedge} \\ \text { in./(mm) } \end{gathered}$ | $\begin{gathered} \mathrm{F}^{\wedge} \\ \text { in./(mm) } \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| .236/(6.00) | 1.704/(43.28) | .622/(15.80) | .202/(5.13) | 1.626/(41.30) | .567/(14.40) | .136/(3.45) |
| . $315 /(8.00$ ) | 1.704/(43.28) | .622/(15.80) | .273/(6.93) | 1.626/(41.30) | .567/(14.40) | .211/(5.36) |
| .500/(12.70) | 1.704/(43.28) | .622/(15.80) | .462/(11.73) | 1.626/(41.30) | .567/(14.40) | .211/(5.36) |
| .750/(19.05) | 1.704/(43.28) | .622/(15.80) | .712/(18.09) | 1.626/(41.30) | .567/(14.40) | .211/(5.36) |
| .236/(6.00) | 1.704/(43.28) | .722/(18.34) | .202/(5.13) | 1.626/(41.30) | .667/(16.94) | .136/(3.45) |
| .315/(8.00) | 1.704/(43.28) | .722/(18.34) | .273/(6.93) | 1.626/(41.30) | .667/(16.94) | .211/(5.36) |
| .500/(12.70) | 1.704/(43.28) | .722/(18.34) | .462/(11.73) | 1.626/(41.30) | .667/(16.94) | .211/(5.36) |
| .750/(19.05) | 1.704/(43.28) | .722/(18.34) | .712/(18.09) | 1.626/(41.30) | .667/(16.94) | .211/(5.36) |
| .236/(6.00) | 2.204/(55.98) | .722/(18.34) | .202/(5.13) | 2.126/(54.00) | .667/(16.94) | .136/(3.45) |
| .315/(8.00) | 2.204/(55.98) | .722/(18.34) | .273/(6.93) | 2.126/(54.00) | .667/(16.94) | .211/(5.36) |
| .500/(12.70) | 2.204/(55.98) | .722/(18.34) | .462/(11.73) | 2.126/(54.00) | .667/(16.94) | .211/(5.36) |
| .750/(19.05) | 2.204/(55.98) | .722/(18.34) | .712/(18.09) | 2.126/(54.00) | .667/(16.94) | .211/(5.36) |
| .236/(6.00) | 2.704/(68.68) | .722/(18.34) | .202/(5.13) | 2.626/(66.70) | .667/(16.94) | .136/(3.45) |
| Additional mated heights coming soon. Consult factory. |  |  |  |  |  |  |

[^1]inch/(mm)
Products shown covered by patents issued and/or pending. Specifications subject to change without notice.

## Board to Board Connectors

- 240 Positions
- 30x8 Rows
- 400 Positions
- $40 \times 10$ Rows
- $50 \times 10$ Rows


## Packaging \& Options:

Male connectors - supplied with a pick-up cap to protect male pins and facilitate automated pick-andplace. Pick-up cap remains in place during reflow.
Female connectors - supplied with a polyimide dot to facilitate automated pick-and-place.
Tape and Reel - Add -TR to end of part number for Tape and Reel packaging.
Standard Trays - If no packaging code is indicated, connectors are shipped in standard trays (Note: Trays are not suitable for automated pick-and-place processes.)

## Available Online:

- RoHS Qualification Test Report
- Product Specification
- Test data
- Signal Integrity Data
- CAD Drawings


[^0]:    $\stackrel{\downarrow}{\stackrel{\rightharpoonup}{\wedge}}$
    .050/(1.27)
    Typ.

[^1]:    *Approximate dimension after soldering. ^Dimensions do not include solder ball height.

